

Low VF SMD Schottky Barrier Diode

FEATURES

- Low power loss, high current capability, low VF
- Surface device type mounting
- Moisture sensitivity level 1
- Matte Tin(Sn) lead finish with Nickel(Ni) underplate
- Packing code with suffix "G" means green compound (halogen-free)





SOD-123



MECHANICAL DATA

- Case: SOD-123 small outline plastic package
- Molding compound, UL flammability classification rating 94V-0
- Terminal: Matte tin plated, lead free, solderable per MIL-STD-202, Method 208 guar
- High temperature soldering guaranteed : 260°C/10s
- Polarity: Indicated by cathode band
- Weight: 0.01 g (approximately)

| PARAMETER | SYMBOL | SD103AW | SD103BW | SD103CW | UNIT |
|--|------------------|-------------|---------|---------|------|
| Power Dissipation | P _D | | 400 | • | mW |
| Repetitive Peak Reverse Voltage | V_{RRM} | 40 | 30 | 20 | V |
| Reverse Voltage | V _R | 28 | 21 | 14 | V |
| Mean Forward Current @ T _L = 100°C | Io | | 350 | | mA |
| Repetitive Peak Forward Surge Current $\textcircled{0}$ t \leq 1.0 s | I _{FRM} | | 1.5 | | Α |
| Thermal Resistance (Junction to Ambient) | $R_{\theta JA}$ | 300 | | °C/W | |
| Junction Temperature | TJ | 125 | | °С | |
| Storage Temperature Range | T _{STG} | -65 to +125 | | | ٥С |

| PARAM | SYMBOL | MIN | TYP | MAX | Units | |
|--|--------------------------------|----------------|-----|-----|-------|----|
| | SD103AW I _R = 10 μA | | 40 | | | |
| Reverse Breakdown Voltage | SD103BW $I_R = 10 \mu A$ | $V_{(BR)}$ | 30 | - | - | V |
| | SD103CW I _R = 10 μA | | 20 | | | |
| Farmed Valtage | I _F = 20 mA | | - | - | 0.37 | V |
| Forward Voltage | $I_F = 200 \text{ mA}$ | V_{F} | | | 0.60 | |
| | SD103AW V _R = 30 V | | | | | |
| Reverse Leakage Current | SD103BW $V_R = 20 V$ | I _R | - | - | 5 | μA |
| | SD103CW $V_R = 10 \text{ V}$ | | | | | |
| Junction Capacitance $V_R = 0$, $f = 1.0 \text{ MHz}$ | | CJ | 50 | | | pF |



RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)

Fig. 1 Typical Forward Characteristics

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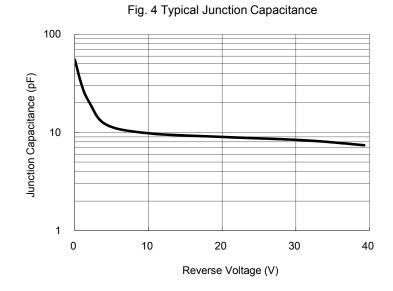
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Fig. 2 Forward Current Derating Curve 0.42 0.35 I_o, Mean Forward Current (A) 0.28 0.21 0.14 0.07 0 0 25 50 75 100 125 150 Terminal Temperature (°C)

Fig. 3 Admissible Power Dissipation Curve 450 400 350 Power Dissipation (mW) 300 250 200 150 100 50 0 0 25 75 125 150 100 Ambient Temperature (°C)





Taiwan Semiconductor

Small Signal Product

| ORDERING INFORMATION | | | | | | |
|----------------------|-----------------|---------|--------------|---------|-----------------|--|
| PART NO. | PART NO. | PACKING | PACKING CODE | PACKAGE | PACKING | |
| | SUFFIX (Note 2) | CODE | SUFFIX | PACKAGE | PACKING | |
| SD103xW | vv | RH G | | SOD-123 | 3.000 / 7" Reel | |
| (Note 1) | (Note 1) | | J G | 30D-123 | 5,000 / / Neel | |

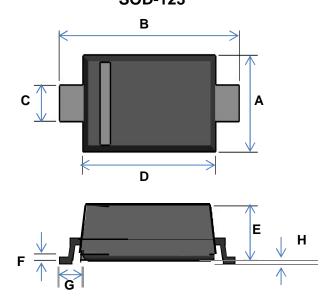
Note 1: "x" is Device Code from "A" thru "C".

Note 2: Part No. Suffix "-xx " would be used for special requirement

| EXAMPLE | | | | | |
|-----------------------|----------|--------------------|--------------|------------------------|--|
| PREFERRED PART NO. | PART NO. | PART NO. SUFFIX | PACKING CODE | PACKING CODE SUFFIX | DESCRIPTION |
| SD103AW RH | SD103AW | | RH | | Multiple manufacture source |
| SD103AW RHG | SD103AW | | RH | G | Multiple manufacture source Green compound |
| SD103AW-D0 RFG | SD103AW | -D0 | RF | G | Define manufacture source Green compound |

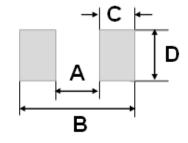


PACKAGE OUTLINE DIMENSIONS **SOD-123**



| DIM. | Unit | (mm) | Unit (inch) | | |
|--------|----------|------|-------------|-------|--|
| DIIVI. | Min | Max | Min | Max | |
| Α | 1.40 | 1.80 | 0.055 | 0.071 | |
| В | 3.55 | 3.85 | 0.140 | 0.152 | |
| С | 0.45 | 0.70 | 0.018 | 0.028 | |
| D | 2.55 | 2.85 | 0.100 | 0.112 | |
| Е | 0.95 | 1.35 | 0.037 | 0.053 | |
| F | 0.05 | 0.15 | 0.002 | 0.006 | |
| G | 0.50 REF | | 0.02 | REF | |
| Н | - | 0.10 | - | 0.004 | |

SUGGEST PAD LAYOUT



| DIM. | Unit (mm) | Unit (inch) | | |
|--------|-----------|-------------|--|--|
| DIIVI. | Тур. | Тур. | | |
| Α | 2.36 | 0.093 | | |
| В | 4.19 | 0.165 | | |
| С | 0.91 | 0.036 | | |
| D | 1.22 | 0.048 | | |

MARKING

| Part No. | Marking |
|----------|---------|
| SD103AW | S4 |
| SD103BW | S5 |
| SD103CW | S6 |





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Document Number: DS_S1411004 Version: C14